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Vishay Siliconix

E Series Power MOSFET



PRODUCT SUMMARY						
V _{DS} (V) at T _J max.	650					
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.043				
Q _g max. (nC)	98					
Q _{gs} (nC)	28					
Q _{gd} (nC)	14					
Configuration	Single					

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
- Welding
- Induction heating
- Motor drives
- Battery chargers
- Solar (PV inverters)

ORDERING INFORMATION				
Package	PowerPAK 10 x 12			
Lead (Pb)-free and halogen-free	SIHK045N60E-T1-GE3			

ABSOLUTE MAXIMUM RATINGS	(T _C = 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	600	V
Gate-source voltage			V _{GS}	± 30	v
Continuous drain current (T _J = 150 °C)	V at 10 V	T _C = 25 °C		48	
	V _{GS} at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	I _D	31	А
Pulsed drain current ^a			I _{DM}	138	
Linear derating factor				2.22	W/°C
Single pulse avalanche energy ^b			E _{AS}	286	mJ
Maximum power dissipation			PD	278	W
Operating junction and storage temperature ra	nge		T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope $T_J = 125 \text{ °C}$		dy/dt	100	V/ns	
Reverse diode dv/dt d			dv/dt 17		v/ns

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 $\Omega,~I_{AS}$ = 4.5 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C

RoHS



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THERMAL RESISTANCE RAT	NGS							
PARAMETER	SYMBOL	TYP. MAX.			UNIT			
Maximum junction-to-ambient	R _{thJA}	- 50 °						
Maximum junction-to-case (drain)	R _{thJC}	- 0.45				°C/W		
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, u	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 µA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_J$	Referenc	e to 25 °C,	, I _D = 1 mA	-	0.64	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 µA	3.0	-	5.0	V
		$V_{GS} = \pm 20 V$			-	-	± 100	nA
Gate-source leakage	I _{GSS}	l l	$V_{GS} = \pm 30 \text{ V}$			-	± 1	μA
Zero gete veltege drein ourrent		V _{DS} =	: 600 V, V _G	_S = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V _{DS} = 480 V	', V _{GS} = 0 V	/, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	١	_D = 17 A	-	0.043	0.049	Ω
Forward transconductance ^a	9 _{fs}	V _{DS} :	= 10 V, I _D =	= 35 A	-	22	-	S
Dynamic								
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	4013	-	pF	
Output capacitance	C _{oss}			-	148	-		
Reverse transfer capacitance	C _{rss}			-	6	-		
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	117	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	744	-		
Total gate charge	Qg				-	65	98	
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 17 \text{ A}, \text{ V}_{DS} = 480 \text{ V}$		-	28	-	nC	
Gate-drain charge	Q _{gd}				-	14	-	
Turn-on delay time	t _{d(on)}		•		-	35	70	
Rise time	t _r	$V_{DD} = 480 \text{ V}, \text{ I}_{D} = 17 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$ $\text{f} = 1 \text{ MHz}$		-	40	80	ns	
Turn-off delay time	t _{d(off)}			-	67	101		
Fall time	t _f			-	14	28		
Gate input resistance	R _g			0.4	0.8	1.6	Ω	
Drain-Source Body Diode Characteristi		•						
Continuous source-drain diode current	۱ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	48	A	
Pulsed diode forward current				-	_	148		
	I _{SM}							
Diode forward voltage		T _J = 25 °C	C, I _S = 17 A	, V _{GS} = 0 V	-	-	1.2	V
Diode forward voltage Reverse recovery time	V _{SD}				-	- 403	1.2 806	V ns
•		T _J = 25	C, I _S = 17 A 5 °C, I _F = I _S 100 A/µs, \	₃ = 17 A,	- - -			

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

c. When mounted on 1" x 1" FR4 board



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

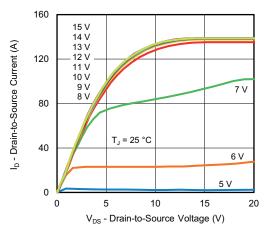


Fig. 1 - Typical Output Characteristics

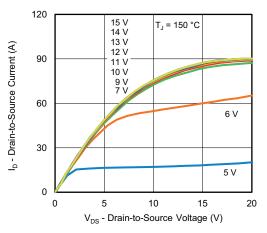


Fig. 2 - Typical Output Characteristics

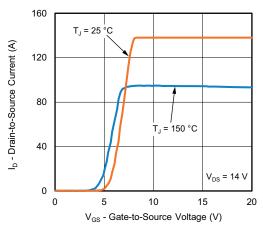


Fig. 3 - Typical Transfer Characteristics

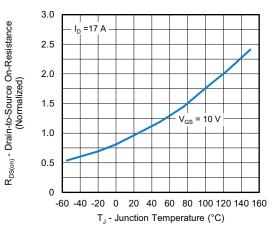


Fig. 4 - Normalized On-Resistance vs. Temperature

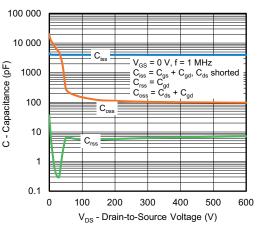


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

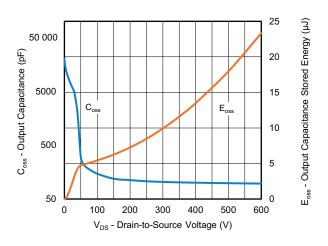


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

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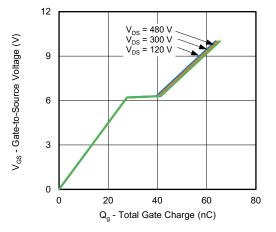


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

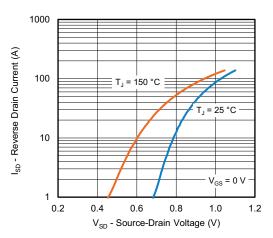


Fig. 8 - Typical Source-Drain Diode Forward Voltage

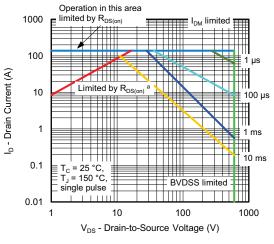


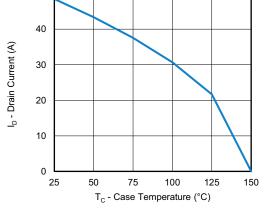
Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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50

Fig. 10 - Maximum Drain Current vs. Case Temperature

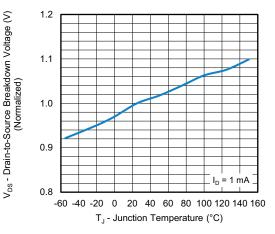
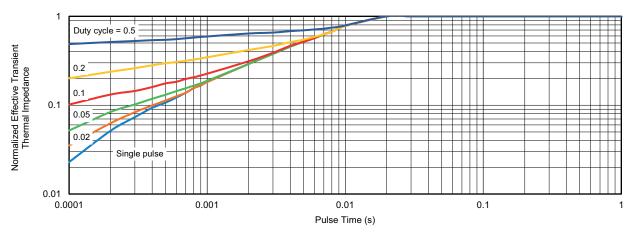


Fig. 11 - Temperature vs. Drain-to-Source Voltage



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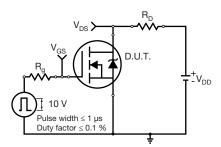


Fig. 13 - Switching Time Test Circuit

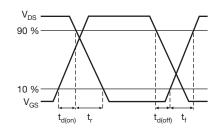


Fig. 14 - Switching Time Waveforms

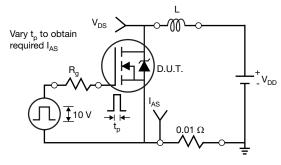


Fig. 15 - Unclamped Inductive Test Circuit

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5 For technical questions, contact: <u>hvm@vishay.com</u>

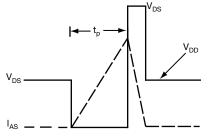


Fig. 16 - Unclamped Inductive Waveforms

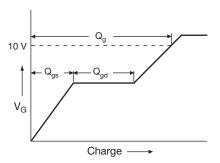
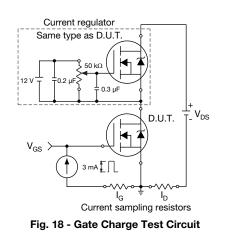


Fig. 17 - Basic Gate Charge Waveform



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Peak Diode Recovery dv/dt Test Circuit

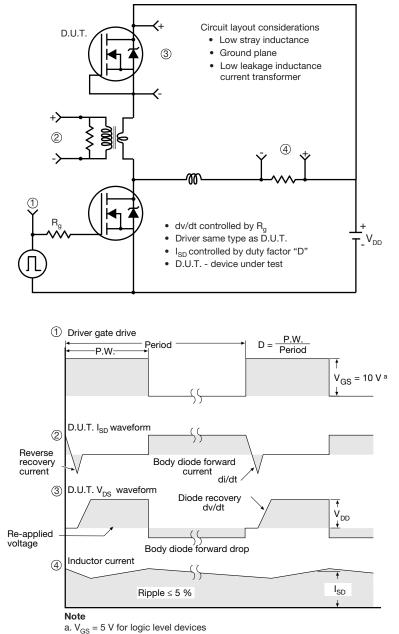


Fig. 19 - For N-Channel

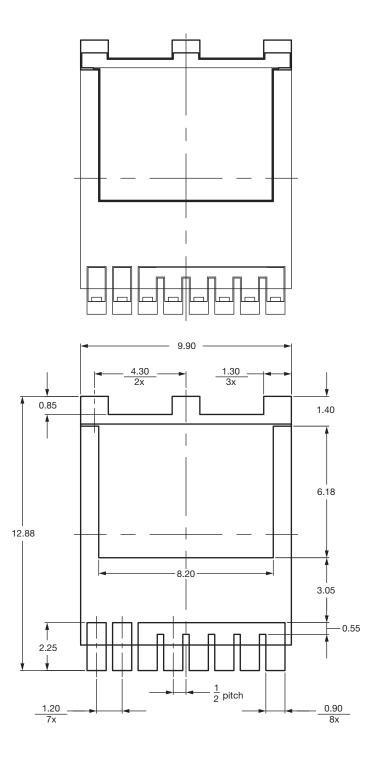
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PAD Pattern



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Recommended Land Pattern PowerPAK[®] 10 x 12 (TOLL) (High Voltage)



Note

• Dimensions in mm

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Revision: 26-Dec-2022

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 92489

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